

# **Product Change Notification**

### CN-202408020F

Issue date: 21 Aug 2024

Effective date: 03 Dec 2024

Here's your personalized quality information concerning products our customers and partners purchased from Nexperia.

For more details please contact your respective Nexperia CSR/AM.



Release of additional assembly and test location for T12 LFPAK88 products

# Change Category

[]Wafer	[]			
Fab	Assembly		[V] Toot	
Process	Process	[] Product Marking	[X] Test Location	[] Design
[] Wafer Fab	[] Assembly	[] Mechanical Specification	[] Test	[] Errata
	•	Specification	Process	[] Electrical
Materials	Materials	[]	[] Test	spec./Test
[]Wafer	[X]	Packing/Shipping/Labeling	Equipment	coverage
Fab	Assembly		Equipment	
Location	Location			

## **Details of this change**

To improve supply security and manufacturing capability, Nexperia has qualified additional assembly and final test location for Trench 12 LFPAK88 (SOT1235) types at ATCB (Philippines). Upon release Nexperia will have multiple assembly sources with LFPAK88 products assembled at either ATSN (Malaysia) or ATCB (Philippines).

CN-202408020FSOT1235ATCBQualificationResults.pdf:

https://qcm.nexperia.com/Document/DOC-579209/CN-202408020FSOT1235ATCBQualificationResults.pdf

# Why do we implement this change?

To meet customer expectations for multiple sourcing as a business contingency. From implementation date Nexperia will have increased supply security provided by multiple manufacturing locations.

# **Identification of affected products**

Top Side Marking

Manufacturing location on 2nd line of Marking

### **Management summary**

Release of additional assembly and test location for T12 LFPAK88 products

### **Product availability**

#### **Production**

Planned first shipment: 03 Dec 2024

### Sample information

Samples are available upon request

### **Impact**

No impact to the product's functionality anticipated

#### Data sheet revision

No impact to existing datasheet

# **Disposition of old products**

Existing product to be shipped alongside products assembled in ATCB.

#### Feedback

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 20 Sep 2024. Lack of acknowledgement of the PCN constitutes acceptance of the change.

### **Additional information**

View Change Notification Online

# **Contact and support**

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support Team.

For specific questions on this notice or the products affected please contact our specialist directly: <a href="mailto:pcn@nexperia.com">pcn@nexperia.com</a>

In case of distribution, please contact you distribution partner.

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